

UV962F

PRODUCT DESCRIPTION

UV962F provides the following product

characteristics:

| cnaracteristics: | |
|------------------|---|
| Technology | Acrylate |
| Appearance | Translucent light blue |
| Product Benefits | Fast cure |
| | One component |
| | Cures in shadowed areas |
| | Easy dispensability without stringing |
| | Fluorescent |
| Cure | Ultraviolet (UV)/ moisture |
| Application | Assembly |
| Typical Package | Local protection of WLCSP and BGA on |
| Application | circuit board |

encapsulant is designed for local circuit board protection. This product is fluorescent when viewed with ultraviolet (black) light.

UV 962F no flow, UV/moisture cure

TYPICAL PROPERTIES OF UNCURED MATERIAL

| Viscosity, Rheometer, Cone and Plate, mPa·s (cP): | |
|---|-------|
| @ 2 s ⁻¹ | 6,600 |
| @ 20 s ⁻¹ | 1,300 |
| Shelf Life @ 5°C, days | 180 |

Flash Point - See SDS

TYPICAL CURING PERFORMANCE

Recommended UV Cure

Light Source and Condition:

Metal halide doped spectrum UV lamp

Light Intensity, mW/cm² 100

UV Wavelength, nm 365

Recommended Dose, seconds 20

Depth of Cure

Cures at least 0.20 inch under optimum conditions.

UV962F can be cured by exposure to UV and/or visible light of sufficient intensity. Cure rate and ultimate depth of cure depend on light intensity, spectral distribution of light source, exposure time and light transmittance of the substrate through which the light must pass.

Moisture cures occurs at ambient temperature and humidity.

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

DMA and TMA tests conducted on samples UV + 7 days moisture (RT, 50% RH) cured.

Hardness, Tq and modulus increases with additional moisture cure.

CTE decreases with additional moisture cure.

Physical Properties

| Hardness, Shore D, After initial UV dose of 6.4 J/cm ² , moisture | | |
|--|-----|--|
| cure condition of 100%RH @ room temperature: | | |
| Initial, after UV Cure | 55 | |
| + 1 day moisture cure | 62 | |
| + 3 days moisture cure | 70 | |
| + 7 days moisture cure | 75 | |
| Coefficient of Thermal Expansion , TMA, ppm/°C: | | |
| Below Tg | 78 | |
| Above Tg | 189 | |
| | | |
| Glass Transition Temperature (Tg) by TMA, °C | 56 | |

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

DIRECTIONS FOR USE

- Use cotton gloves to handle syringe. Touching the syringe with bare hands may induce thaw voids between the adhesive and inside walls of the syringe.
- Handle the syringes by the end or, if packaged in bags, by the corner. A
 warm hand holding a cold syringe can sometimes cause formation of
 freeze/thaw voids.
- Complete cleaning of the substrates should be performed to remove contamination such as oxide layers, dust, moisture, salt and oils which can cause poor adhesion or corrosion in a bonded part.
- 4. Usable shelf life may vary depending on method of application and storage conditions.

THAWING:

- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- 2. Once material has reached room temperature, the adhesive should not be re-refrigerated.
- 5. Voids can form in the syringes if syringes are repeatedly re-refrigerated.
- Typical thaw/warm-up times for different package sizes are shown below:
 @ 25°C, 30 cc syringes, minutes
 @ 25°C, 55 cc syringes, hours
- 5. For optimal performance, a consistent dispense temperature is recommended. This will reduce the effects of a potential temperature change between storage place and cleaning room.

| Storage | |
|--|--|
| Store in original, tightly covered containers in clean, dry areas. Storage information may be indicated on the product container labeling. | |
| Optimal Storage : 5 °C | |
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